

# Central<sup>TM</sup> Semiconductor Corp.

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Manufacturers of World Class Discrete Semiconductors

www.centrasemi.com

CS65-70B  
CS65-70D  
CS65-70M  
CS65-70N  
CS65-70P  
CS65-70PB

SILICON CONTROLLED RECTIFIER  
70 AMPS RMS, 200 THRU 1200 VOLTS

TO-65 CASE

## DESCRIPTION

The CENTRAL SEMICONDUCTOR CS65-70B series types are High Power Silicon Controlled Rectifiers designed for phase control applications.

## MAXIMUM RATINGS (T<sub>A</sub>=25°C unless otherwise noted)

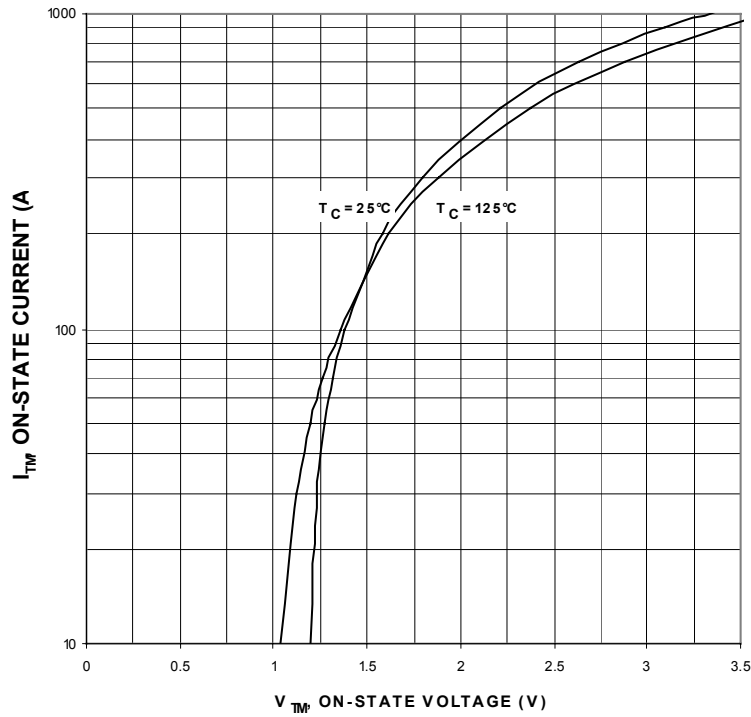
	SYMBOL	CS65 -70B	CS65 -70D	CS65 -70M	CS65 -70N	CS65 -70P	CS65 -70PB	UNITS
Peak Repetitive Off-State Voltage	V <sub>DRM</sub> , V <sub>RRM</sub>	200	400	600	800	1000	1200	V
Peak Non-Repetitive Reverse Voltage	V <sub>RSM</sub>	300	500	700	900	1100	1300	V
RMS On-State Current (T <sub>C</sub> =102°C)	I <sub>T(RMS)</sub>				63			A
Average On-State Current (T <sub>C</sub> =102°C)	I <sub>T(AV)</sub>				40			A
Peak One Cycle Surge ( 60Hz)	I <sub>TSM</sub>				1000			A
I <sup>2</sup> t Value for Fusing (t=8.3ms)	I <sup>2</sup> t				4100			A <sup>2</sup> s
Peak Forward Gate Voltage	V <sub>FGM</sub>				20			V
Peak Reverse Gate Voltage	V <sub>RGM</sub>				10			V
Peak Gate Power	P <sub>GM</sub>				10			W
Average Gate Power (tp=10µs)	P <sub>G(AV)</sub>				1.0			W
Peak Gate Current	I <sub>GM</sub>				3.0			A
Critical Rate of Rise of On-State Current	di/dt				200			A/µs
Storage Temperature	T <sub>stg</sub>				-65 to +150			°C
Junction Temperature	T <sub>J</sub>				-65 to +125			°C
Thermal Resistance	Θ <sub>J-C</sub>				0.35			°C/W

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C unless otherwise noted)

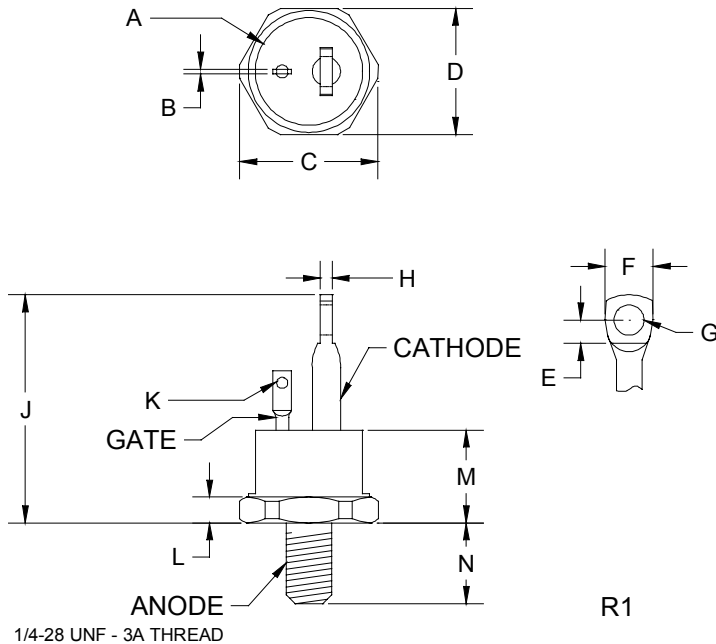
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I <sub>DRM</sub> , I <sub>RRM</sub>	Rated V <sub>DRM</sub> , V <sub>RRM</sub> , T <sub>C</sub> =125°C			6.0	mA
I <sub>GT</sub>	V <sub>D</sub> =12V, R <sub>L</sub> =33Ω			100	mA
I <sub>H</sub>	I <sub>T</sub> =500mA			200	mA
V <sub>GT</sub>	V <sub>D</sub> =12V, R <sub>L</sub> =33Ω			3.0	V
V <sub>TM</sub>	I <sub>TM</sub> =500A			3.0	V
dv/dt	V <sub>D</sub> =.67 x V <sub>DRM</sub> , T <sub>C</sub> =125°C	200			V/µs

(SEE REVERSE SIDE)

**MAXIMUM ON-STATE CHARACTERISTICS**



**TO-65 PACKAGE - MECHANICAL OUTLINE**



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A (DIA)	-	0.667	-	16.94
B	0.025	0.030	0.64	0.76
C	-	0.770	-	19.56
D	0.677	0.685	17.20	17.40
E	0.120	-	3.05	-
F	0.200	0.300	5.08	7.62
G (DIA)	0.145	0.155	3.68	3.93
H	0.065	0.085	1.65	2.15
J	1.200	1.250	30.48	31.75
K (DIA)	0.055	0.065	1.40	1.65
L	0.115	0.155	2.92	3.94
M	-	0.515	-	13.08
N	0.427	0.447	10.84	11.35

TO-65 (REV: R1)

R1

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